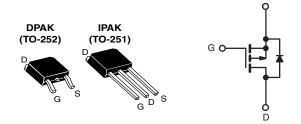


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	-60				
R _{DS(on)} (Ω)	V _{GS} = -10 V 0.50				
Q _g max. (nC)	12				
Q _{gs} (nC)	3.8				
Q _{gd} (nC)	5.1				
Configuration	Single				



P-Channel MOSFET

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Surface mount (IRFR9014, SiHFR9014)
- Straight lead (IRFU9014, SiHFU9014)
- Available in tape and reel
- P-channel
- · Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION						
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)		
Lead (Pb)-free and Halogen-free	SiHFR9014-GE3	SiHFR9014TRL-GE3 a	SiHFR9014TR-GE3 a	SiHFU9014-GE3		
Lead (Pb)-free	IRFR9014PbF	IRFR9014TRLPbF a	IRFR9014TRPbF ^a	IRFU9014PbF		

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	-60	v
Gate-Source Voltage			V _{GS}	± 20	v
Continuous Drain Current V_{GS} at 5.0 V $T_C = 25 \degree C$ $T_C = 100 \degree C$			1	-5.1	
Continuous Drain Current	ID	-3.2	А		
Pulsed Drain Current ^a	I _{DM}	-20			
Linear Derating Factor		0.20	W/°C		
Linear Derating Factor (PCB mount) ^e		0.020	V/*C		
Single Pulse Avalanche Energy ^b		E _{AS}	140	mJ	
Repetitive Avalanche Current ^a			I _{AR}	-5.1	A
Repetitive Avalanche Energy ^a			E _{AR}	2.5	mJ
Maximum Power Dissipation	25 °C	P	25	۱۸/	
Maximum Power Dissipation (PCB mount) e	P _D 2.5		- W		
Peak Diode Recovery dV/dt ^c	dV/dt	-4.5	V/ns		
Operating Junction and Storage Temperature Range	е		T _J , T _{stg}	-55 to +150	- °C
Soldering Recommendations (Peak temperature) ^d	for	10 s	-	260	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = -25$ V, starting $T_J = 25$ °C, L = 6.3 mH, $R_g = 25 \Omega$, $I_{AS} = -5.1$ A (see fig. 12).

c. $I_{SD} \leq$ - 6.7 A, dI/dt \leq 90 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq$ 150 °C.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

S16-0015-Rev. E, 18-Jan-16







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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	-	110		
Maximum Junction-to-Ambient (PCB mount) ^a	R _{thJA}	-	-	50	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	5.0		

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		-					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D =$	- 250 μA	-60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 2	5 °C, I _D = -1 mA	-	-0.059	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D =$	-250 μA	-2.0	-	-4.0	V
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60 V, V_{C}$ $V_{DS} = -48 V, V_{C}$	_{iS} = 0 V _{iS} = 0 V, T _J = 125 °C	-	-	-100 -500	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = -10 V$ $I_D = -3.1 A^{b}$		-	-	0.50	Ω
Forward Transconductance	g _{fs}	$V_{DS} = -25 V, I_{D}$	= -3.1 A ^b	1.4	-	-	S
Dynamic	-	•			<u> </u>		
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$		-	270	-	
Output Capacitance	Coss	$V_{DS} = -25 V$,		-	170	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, se	e fig. 5	-	31	-	
Total Gate Charge	Qg			-	-	12	nC
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	$I_D = -6.7 \text{ A}, V_{DS} = -48 \text{ V},$ see fig. 6 and 13 ^b	-	-	3.8	
Gate-Drain Charge	Q _{gd}		see lig. 0 and 15	-	-	5.1	
Turn-On Delay Time	t _{d(on)}			-	11	-	
Rise Time	tr	$V_{DD} = -30 \text{ V}, \text{ I}_{D}$	= -6.7 A,	-	63	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 24 \Omega, R_D =$	= 4.0 Ω , see fig. 10 ^b	-	9.6	-	ns
Fall Time	t _f			-	31	-	
Internal Drain Inductance	L _D	Between lead,	ر لر	-	4.5	-	
Internal Source Inductance	L _S	()	6 mm (0.25") from package and center of die contact ^c		7.5	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	ا _S	MOSFET symb	ol	-	-	-5.1	
Pulsed Diode Forward Current ^a	I _{SM}	showing the integral reverse p - n junction d		-	-	-20	А
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S =	-5.1 A, V _{GS} = 0 V ^b	-	-	-5.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1	67 A dl/dt 100 A/. b	-	80	160	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25 {}^{-}\rm{C}, I_{\rm F} =$	-6.7 A, dl/dt = 100 A/µs ^b	-	0.096	0.19	μC
Forward Turn-On Time	t _{on}	Intrinsic turi	n-on time is negligible (turn	-on is dor	ninated b	v Ls and	Ln)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

2

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

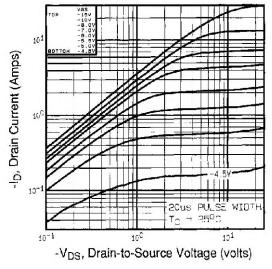


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

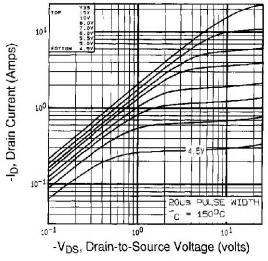


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

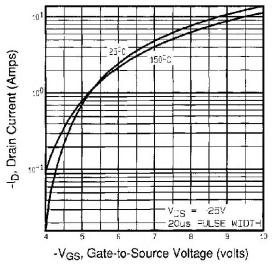


Fig. 3 - Typical Transfer Characteristics

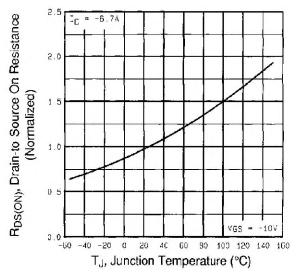


Fig. 4 - Normalized On-Resistance vs. Temperature



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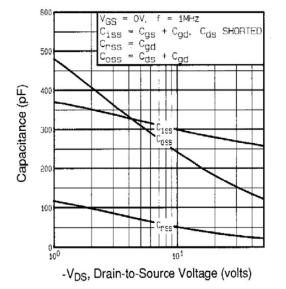


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

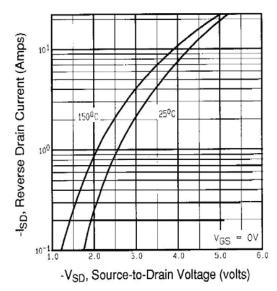


Fig. 7 - Typical Source-Drain Diode Forward Voltage

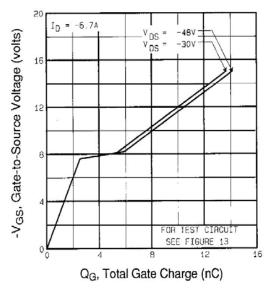
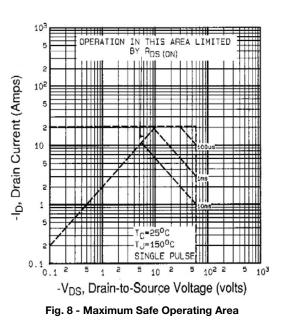


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





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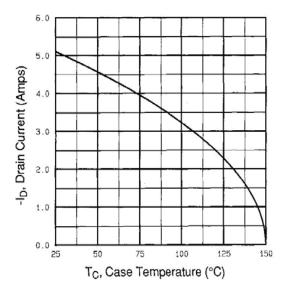


Fig. 9 - Maximum Drain Current vs. Case Temperature

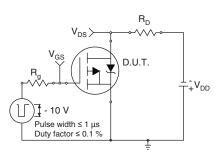


Fig. 10a - Switching Time Test Circuit

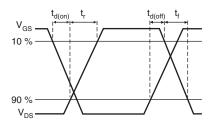


Fig. 10b - Switching Time Waveforms

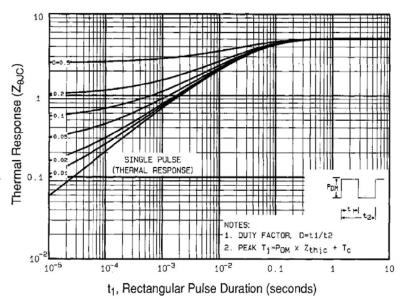


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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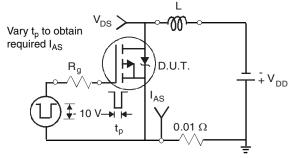


Fig. 12a - Unclamped Inductive Test Circuit

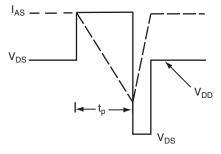


Fig. 12b - Unclamped Inductive Waveforms

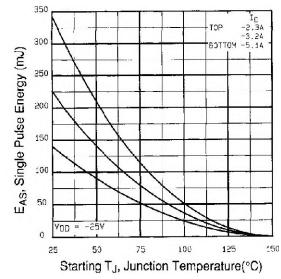


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

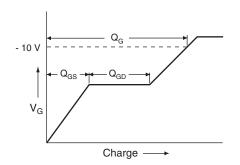


Fig. 13a - Basic Gate Charge Waveform

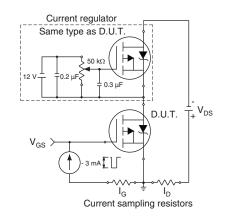


Fig. 13b - Gate Charge Test Circuit

S16-0015-Rev. E, 18-Jan-16

6

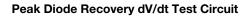
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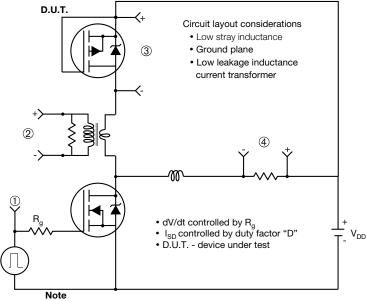
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• Compliment N-Channel of D.U.T. for driver

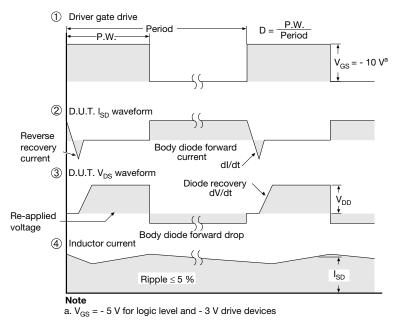


Fig. 14 - For P-Channel

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TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	BSC		
e1	4.56	BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

Note

• Dimension L3 is for reference only



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VERSION 2: FACILITY CODE = N



	MILLIMETERS				
DIM.	MIN.	MAX.			
A	2.18	2.39			
A1	-	0.13			
b	0.65	0.89			
b1	0.64	0.79			
b2	0.76	1.13			
b3	4.95	5.46			
С	0.46	0.61			
c1	0.41	0.56			
c2	0.46	0.60			
D	5.97	6.22			
D1	5.21	-			
E	6.35	6.73			
E1	4.32	-			
е	2.29	BSC			
Н	9.94	10.34			

	MILLIMETERS				
DIM.	MIN.	MAX.			
L	1.50	1.78			
L1	2.74	l ref.			
L2	0.51	BSC			
L3	0.89	1.27			
L4	-	1.02			
L5	1.14	1.49			
L6	0.65	0.85			
θ	0°	10°			
θ1	0°	15°			
θ2	25°	35°			

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347



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TO-251AA (HIGH VOLTAGE)



	MILLI	METERS	INCHES		MILLIMETERS		MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA	
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-	
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2	
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-	
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC	
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3	
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0	
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0	
с	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0	
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15	
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35	
D	5.97	6.22	0.235	0.245		•	•	•		

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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